

## CLAIMS

I claim:

- 1        1. A system comprising:
  - 2            a case;
  - 3            a component mounted on the case; and
  - 4            a string positioned between the component and the case, the string comprising a longitudinal element and a plurality of conductive filaments
  - 5            transversely mounted on the longitudinal element.
- 1        2. The system of claim 1 wherein at least a portion of the plurality of the conductive filaments of the string contact the case and the component.
- 1        3. The system of claim 1 wherein the case defines an interior, an opening being formed in the case between the interior of the case and an exterior of the case.
- 1        4. The system of claim 3 wherein the component is positioned adjacent to the opening in the case, and the string is positioned adjacent to the opening.
- 1        5. The system of claim 3 wherein the opening has a perimeter with a length, the string being positioned adjacent to at least a portion of the length of the perimeter of the opening.
- 1        6. The system of claim 3 wherein the perimeter of the opening is substantially rectangular with sides, the string being positioned adjacent to at least one of the sides of the perimeter of the opening in the case.
- 1        7. The system of claim 1 wherein the component comprises a power supply.
- 1        8. The system of claim 1 wherein the component comprises a drive.

1        9. The system of claim 3 wherein the component is located in the  
2 interior of the case.

1        10. The system of claim 1 wherein the component is removably  
2 mounted on the case.

1        11. The system of claim 10 wherein the case is configured so that  
2 the component is removable through the opening in the case.

1        12. The system of claim 10 wherein the case configured so that the  
2 component is positionable adjacent to the opening in the case from the  
3 interior of the case.

1        13. The system of claim 1 wherein the component generates  
2 radiation when operating.

1        14. A method of reducing radiation from a case housing at least one  
2 electronic component and having an opening formed therein with a  
3 perimeter, the method comprising:

4        positioning a string having transverse conductive filaments along at  
5 least a portion of the perimeter of the opening; and

6        installing the electronic component adjacent to the opening in the  
7 case with the string being positioned between the component and the case  
8 adjacent to the perimeter of the opening.

1        15. The method of claim 14 wherein the step of installing the  
2 component is performed after the step of positioning the string.

1        16. The method of claim 14 wherein the step of installing the  
2 component comprises inserting the component through the opening in the  
3 case.